Electronic Pate	ent App	lication Fee	Transm	ittal			
Application Number:	105	10595303					
Filing Date:	19-	19-May-2006					
Title of Invention:		FIRM, INSULATING AND ELECTRICALLY CONDUCTING CONNECTION OF PROCESSED SEMICONDUCTOR WAFERS					
First Named Inventor/Applicant Name:	Roy	Roy Knechtel					
Filer:	Chi	Christopher Michael First/Terry Ford					
Attorney Docket Number:	602	60291.000048					
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Fi	iling Fee	5					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Utility Applissue fee		1501	1	1740	1740		

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			2040